

POWER OF ATTORNEY

Georgia Tech Research Corporation, assignee of the application for United States Letters Patent for **METHOD AND DEVICE TO ELONGATE A SOLDER JOINT** invented by **Ee Hua WONG, Ranjan s/o RAJOO, Wai Kwan WONG and Mahadevan Krishna IYER**

☒ filed herewith, or
☐ having Serial No. _____, filed _____

a copy of the assignment of which is attached hereto, does hereby appoint as attorneys of record with full power of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Practitioners at Customer Number 25920.

I, the undersigned, declare that I am the (an) assignee of the above-identified application or, if the assignee is a corporation, partnership or other association, I am authorized to make this appointment on behalf of the assignee and I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Assignee's Name: **Georgia Tech Research Corporation**
Assignee's Address: **505 Tenth Street, NW, Georgia Institute of Technology, Atlanta, Georgia, 30332-0420**

Signature: George Harker Date: Sept. 4, 2003

Declarant's Name: _____

Declarant's Title: **George G. Harker III, Ph.D.**
Director, Technology Licensing

POWER OF ATTORNEY

National University of Singapore, assignee of the application for United States Letters Patent for **METHOD AND DEVICE TO ELONGATE A SOLDER JOINT** invented by **Ee Hua WONG, Ranjan s/o RAJOO, Wai Kwan WONG and Mahadevan Krishna IYER**

☒ filed herewith, or
☐ having Serial No. _____, filed _____

a copy of the assignment of which is attached hereto, does hereby appoint as attorneys of record with full power of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Practitioners at Customer Number 25920.

I, the undersigned, declare that I am the (an) assignee of the above-identified application or, if the assignee is a corporation, partnership or other association, I am authorized to make this appointment on behalf of the assignee and I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Assignee's Name: **National University of Singapore**
Assignee's Address: **10 Kent Ridge Crescent, Singapore 119260**

Signature:  Date: 8 September 2003

Declarant's Name: Mr Tay Kim Huat

Declarant's Title: Deputy Director, Industry and Technology Relations Office

POWER OF ATTORNEY

Agency for Science, Technology and Research, assignee of the application for United States Letters Patent for METHOD AND DEVICE TO ELONGATE A SOLDER JOINT invented by Ee Hua WONG, Ranjan s/o RAJOO, Wai Kwan WONG and Mahadevan Krishna IYER

☒ filed herewith, or
☐ having Serial No. _____, filed _____

a copy of the assignment of which is attached hereto, does hereby appoint as attorneys of record with full power of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

Practitioners at Customer Number 25920.

I, the undersigned, declare that I am the (an) assignee of the above-identified application or, if the assignee is a corporation, partnership or other association, I am authorized to make this appointment on behalf of the assignee and I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Assignee's Name: Agency for Science, Technology and Research
Assignee's Address: 10 Science Park Road, #01-01/03, The Alpha, Singapore Science Park II,
Singapore 117684

Signature: _____  Date: 17 Sept 2003

Declarant's Name: Mr. Suresh Sachi

Declarant's Title: Director, Legal

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
DECLARATION FOR PATENT APPLICATION**

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

METHOD AND DEVICE TO ELONGATE A SOLDER JOINT

the specification of which

(check one)

☒ is attached hereto.

☐ was filed on _____

as U.S. Application Serial No. _____.

☐ was filed on _____

as PCT International Application No. PCT / _____.

and (if applicable) was amended on N.A.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information known to me which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §§ 1.56(a) and (b), which state:

"(a) A patent by its very nature is affected with a public interest. The public interest is best served, and the most effective patent examination occurs when, at the time an application is being examined, the Office is aware of and evaluates the teachings of all information material to patentability. Each individual associated with the filing and prosecution of a patent application has a duty of candor and good faith in dealing with the Office, which includes a duty to disclose to the Office all information known to that individual to be material to patentability as defined in this section. The duty to disclose information exists with respect to each pending claim until the claim is cancelled or withdrawn from consideration, or the application becomes abandoned. Information material to the patentability that is cancelled or withdrawn from consideration need not be submitted if the information is not material to the patentability of any claim remaining under consideration in the application. There is no duty to submit information which is not material to the patentability of any existing claim. The duty to disclose all information known to be material to patentability is deemed to be satisfied if all information known to be material to patentability of any claim issued in a patent was cited by the Office or submitted to the Office in the manner prescribed by §§ 1.97(b)-(d) and 1.98. However, no patent will be granted on an application in connection with which fraud on the Office was practised or attempted or the duty of disclosure was violated through bad faith or intentional misconduct. The Office encourages applicants to carefully examine:

- (1) prior art cited in search reports of a foreign patent office in a counterpart application,
- (2) the closest information over which individuals associated with the filing or prosecution of a patent application believe any pending claim patentably defines, to make sure that any material information contained therein is disclosed to the Office.

(b) Under this section, information is material to patentability when it is not cumulative to information already of record or being made of record in the application, and

- (1) It establishes, by itself or in combination with other information, a prima facie case of unpatentability of a claim; or
- (2) It refutes, or is inconsistent with, a position the applicant takes in:
 - (i) Opposing an argument of unpatentability relied on by the Office, or
 - (ii) Asserting an argument of patentability.

A prima facie case of unpatentability is established when the information compels a conclusion that a claim is unpatentable under the preponderance of evidence, burden-of-proof standard, giving each term in the claim its broadest reasonable construction consistent with the specification, and before any consideration is given to evidence which may be submitted in an attempt to establish a contrary conclusion of patentability."

I hereby claim foreign priority benefits under 35 United States Code, § 119 and/or § 365 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate filed by me or my assignee disclosing the subject matter claimed in this application and having a filing date (1) before that of the application on which priority is claimed, or (2) if no priority claimed, before the filing of this application:

PRIOR FOREIGN APPLICATION(S)

<u>Number</u>	<u>Country</u>	<u>Filing Date</u> <i>(Day/Month/Year)</i>	<u>Date First</u> <u>Laid-open or</u> <u>Published</u>	<u>Date</u> <u>Patented</u> <u>or Granted</u>	<u>Priority</u> <u>Claimed?</u>
---------------	----------------	---	--	---	------------------------------------

N/A

I hereby claim the benefit under 35 United States Code, § 119(e) of any United States provisional application(s) listed below:

<u>Application Number</u>	<u>Filing Date</u>
---------------------------	--------------------

N/A


I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56(a) which became available between the filing date of the prior application and the national or PCT international filing date of this application:


PRIOR U.S. OR PCT APPLICATION(S)


<u>Application No.</u>	<u>Filing Date</u> <i>(day/month/year)</i>	<u>Status</u> <i>(pending, abandoned, granted)</i>
------------------------	---	---


N/A

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that wilful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such wilful false statements may jeopardize the validity of the application or any patent issued thereon.

1) INVENTOR'S SIGNATURE:  Date: 2/9/03
Inventor's Name: Ee Hua WONG
(First) (Middle Initial) (Family Name)
Country of Citizenship: Singapore
Residence: Singapore
(City, Province, Country)
Post Office Address: Blk 20, Choa Chu Kang Street 64, #23-02, Singapore 689093

2) INVENTOR'S SIGNATURE:  Date: 2/9/03
Inventor's Name: Ranjan s/o RAJOO
(First) (Middle Initial) (Family Name)
Country of Citizenship: Singapore
Residence: Singapore
(City, Province, Country)
Post Office Address: Blk 759, Choa Chu Kang North 5, #04-157, Singapore 680759

3) INVENTOR'S SIGNATURE:  Date: 02-09-03
Inventor's Name: Wai Kwan WONG
(First) (Middle Initial) (Family Name)
Country of Citizenship: Britain
Residence: Singapore
(City, Province, Country)
Post Office Address: Blk 543, Woodlands Drive 16, #03-13, Singapore 730543

4) INVENTOR'S SIGNATURE:  Date: 02 Sept 07
Inventor's Name: Mahadevan Krishna IYER
(First) (Middle Initial) (Family Name)
Country of Citizenship: India
Residence: Singapore
(City, Province, Country)
Post Office Address: Blk 723, Clementi West Street 2, #24-180, Singapore 120723